

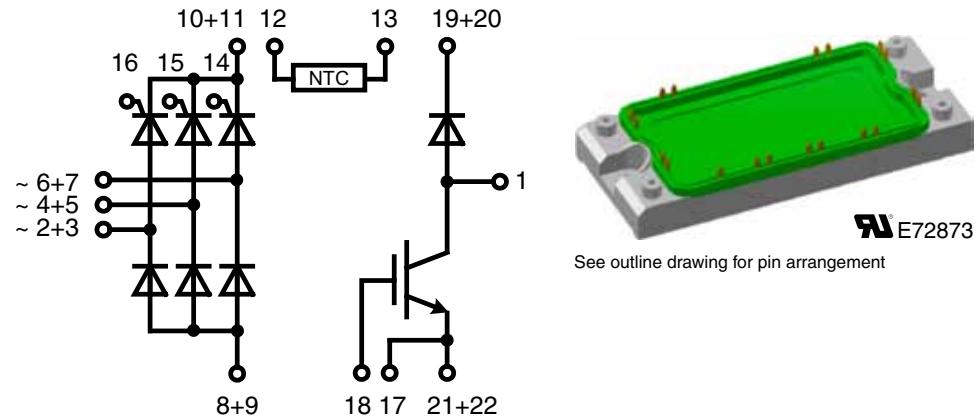
Three Phase Rectifier Bridge

with IGBT and Fast Recovery Diode
for Braking System

Rectifier Diode	Fast Recov. Diode	IGBT
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{dAVM} = 170 \text{ A}$	$V_F = 2.75 \text{ V}$	$I_{C80} = 108 \text{ A}$
$I_{FSM} = 900 \text{ A}$	$I_{FSM} = 200 \text{ A}$	$V_{CEsat} = 2.35 \text{ V}$

Part name (Marking on product)

VVZB170-16IOXT



Features:

- Soldering connections for PCB mounting
- Convenient package outline
- NTC

Application:

- Drive Inverters with brake system

Package:

- Two functions in one package
- Easy to mount with two screws
- Suitable for wave soldering
- High temperature and power cycling capability
- UL registered, E72873

IGBT

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to 150°C			1200	V
V_{GES}	max. DC gate voltage	continuous	-20		+20	V
V_{GEM}	max. transient collector gate voltage	transient	-30		+30	V
I_{C25}	collector current	DC	$T_C = 25^\circ\text{C}$	155	A	
I_{C80}		DC	$T_C = 80^\circ\text{C}$	108	A	
P_{tot}	total power dissipation		$T_C = 25^\circ\text{C}$	500	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 100 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	2.05	2.35	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 4 \text{ mA}$	$T_{VJ} = 25^\circ\text{C}$	5.4	6.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	0.01	0.1	mA
			$T_{VJ} = 125^\circ\text{C}$	0.1		mA
I_{GES}	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$		500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 100 \text{ A}$	295			nC
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600 \text{ V}; I_C = 100 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 6.8 \Omega; L = 100 \mu\text{H}$	70			ns
$t_{d(off)}$	turn-off delay time		250			ns
t_r	current rise time		40			ns
t_f	current fall time		100			ns
E_{on}	turn-on energy per pulse		8.5			mJ
E_{off}	turn-off energy per pulse		11.5			mJ
I_{CM}	reverse bias safe operating area	RBSOA; $V_{GE} = \pm 15 \text{ V}; R_G = 6.8 \Omega; L = 100 \mu\text{H}$	200			A
V_{CEK}		clamped inductive load; $T_{VJ} = 125^\circ\text{C}$			$\leq V_{CES} \cdot L_S \cdot d/dt$	V
SCSOA	short circuit safe operating area	$V_{CE} = 720 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 6.8 \Omega$; non-repetitive				
t_{sc}		$T_{VJ} = 125^\circ\text{C}$		10		μs
I_{sc}				400		A
RBSOA	reverse bias safe operating area	$V_{CE} = 1200 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 6.8 \Omega; L = 100 \mu\text{H}$; clamped inductive load		300		A
R_{thJC}	thermal resistance junction to case			0.25		K/W
R_{thCH}	thermal resistance case to heatsink			0.1		K/W

Fast Recovery Diode

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			1200	V
I_{FAV}	average forward current	rect.; $d = 0.5$	$T_C = 80^\circ\text{C}$		32	A
I_{FRMS}	rms forward current	rect.; $d = 0.5$	$T_C = 80^\circ\text{C}$		45	A
I_{FSM}	max. surge forward current	$t = 10 \text{ ms}$	$T_{VJ} = 45^\circ\text{C}$		200	A
P_{tot}	total power dissipation		$T_C = 25^\circ\text{C}$		130	W
V_{FO}	threshold voltage	$T_{VJ} = 150^\circ\text{C}$			1.3	V
r_F	slope resistance	for power loss calculation only			17	$\text{m}\Omega$
V_F	forward voltage	$I_F = 30 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$		2.75	V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$		0.25	mA
			$T_{VJ} = 125^\circ\text{C}$	1		mA
I_{RM}	reverse recovery current	$I_F = 50 \text{ A}; V_R = 100 \text{ V}; di_F/dt = -100 \text{ A}/\mu\text{s}$		8	11	A
t_{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; di_F/dt = -200 \text{ A}/\mu\text{s}$		40		ns
R_{thJC}	thermal resistance junction to case				0.9	K/W
R_{thCH}	thermal resistance case to heatsink				0.3	K/W

 $T_C = 25^\circ\text{C}$ unless otherwise stated

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Rectifier Bridge

Symbol	Conditions		Ratings		
			min.	typ.	max.
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1600	V
$I_{D(AV)M}$	max. average DC output current sine; $d = 1/3$; bridge	$T_C = 80^\circ C$		170	A
I_{FSM}	max. forward surge current $V_R = 0 V$	$T_{VJ} = 45^\circ C$ $T_{VJ} = 150^\circ C$		1100 960	A A
I^2t	value for fusing $V_R = 0 V$	$T_{VJ} = 45^\circ C$ $T_{VJ} = 150^\circ C$		6050 4610	A ² s A ² s
P_{tot}	total power dissipation	$T_{VJ} = 25^\circ C$		250	W
$(di/dt)_{cr}$	critical rate of rise of current	$f = 50 \text{ Hz}; t_p = 200 \mu s$ $V_D = 2/3 V_{DRM}; T_{VJ} = T_{VJM}$ $I_G = 0.45 A$ $di_G/dt = 0.45 A/\mu s$	repetitive $I_T = 150 A$	150	A/ μs
$(dv/dt)_{cr}$	critical rate of rise of voltage	$V_D = 2/3 V_{DRM}; T_{VJ} = T_{VJM}$ $R_{GK} = \infty$; method 1 (linear voltage rise)		1000	V/ μs
P_{GM}	max. gate power dissipation	$I_T = 1/3 I_{dAV}; T_{VJ} = T_{VJM}$	$t_p = 30 \mu s$ $t_p = 300 \mu s$	10 5	W W
P_{GAVM}				0.5	W
I_R, I_D	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$	0.05 20	mA mA
V_F, V_T	forward voltage	$I_F = 150 A$	$T_{VJ} = 25^\circ C$	1.68	V
V_{TO} r_T	threshold voltage slope resistance	for power loss calculation only		0.87 5.9	V $m\Omega$
V_{GT}	gate trigger voltage	$V_D = 6 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$	1.5 1.6	V V
I_{GT}	trigger gate current	$V_D = 6 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$	95 200	mA mA
V_{GD} I_{GD}	gate non-trigger voltage non-trigger gate current	$V_D = 2/3 V_{DRM}$	$T_{VJ} = T_{VJM}$	0.2 10	V mA
I_L	latching current	$V_D = 6 V; t_G = 10 \mu s$ $di_G/dt = 0.45 A/\mu s; I_G = 0.45 A$		450	mA
I_H	holding current	$V_D = 6 V; R_{GK} = \infty$	$T_{VJ} = T_{VJM}$	200	mA
t_{gd}	gate controlled delay time	$V_D = 1/2 V_{DRM}; di_G/dt = 0.45 A/\mu s; I_G = 0.45 A$		2	μs
t_q	turn-off time	$V_R = 100 V; V_D = 2/3 V_{DRM}$ $t_p = 200 \mu s; I_T = 120 A$ $dv/dt = 20 V/\mu s; -di/dt = 10 A/\mu s$	$T_{VJ} = T_{VJM}$	150	μs
R_{thJC}	thermal resistance junction to case			0.5	K/W
R_{thCH}	thermal resistance case to heatsink			0.1	K/W

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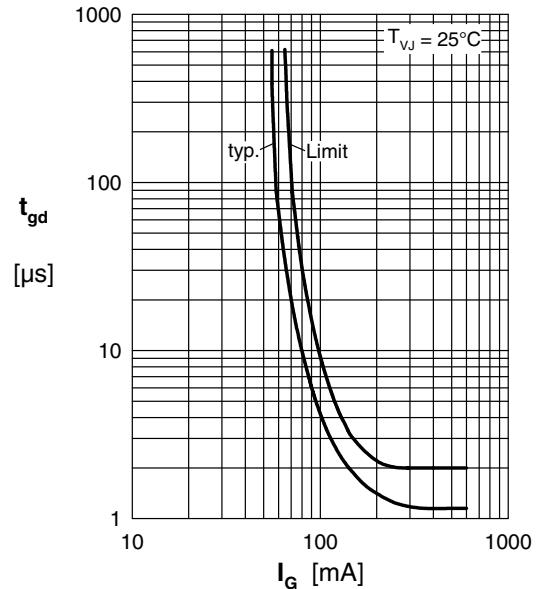
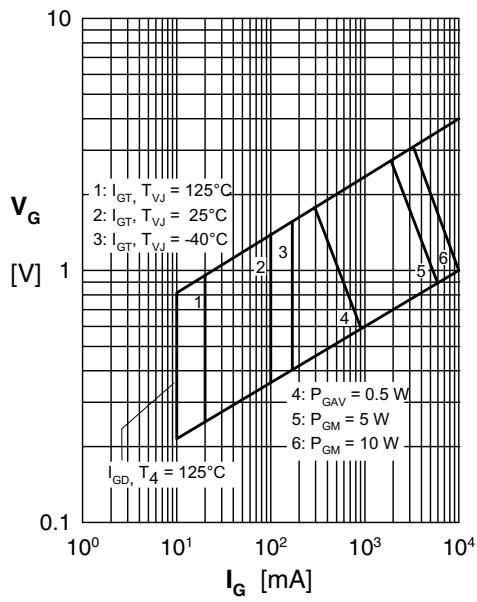
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Module

Ratings							
Symbol	Definitions	Conditions	$T_c = 25^\circ\text{C}$ unless otherwise stated	min.	typ.	max.	Unit
T_{VJ}	operating temperature			-40		150	°C
T_{VJM}	max. virtual junction temperature					150	°C
T_{stg}	storage temperature			-40		125	°C
V_{ISOL}	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz};$	$t = 1 \text{ min.}$ $t = 1 \text{ s}$			3000 3600	V~ V~
M_d	mounting torque			3		6	Nm
d_s	creep distance on surface			12.7			mm
d_A	strike distance through air			9.6			mm
a	maximum allowable acceleration					50	m/s^2
Weight						180	g

Temperature Sensor NTC

Ratings							
Symbol	Definitions	Conditions		min.	typ.	max.	Unit
R_{25}	resistance	$\left\{ R(T) = R_{25} \cdot e^{B_{25/100} \left[\frac{1}{T} - \frac{1}{298K} \right]} \right\}$	$T_{VJ} = 25^\circ\text{C}$	4.75	5.0	5.25	kΩ
$B_{25/85}$					3375		K

Rectifier

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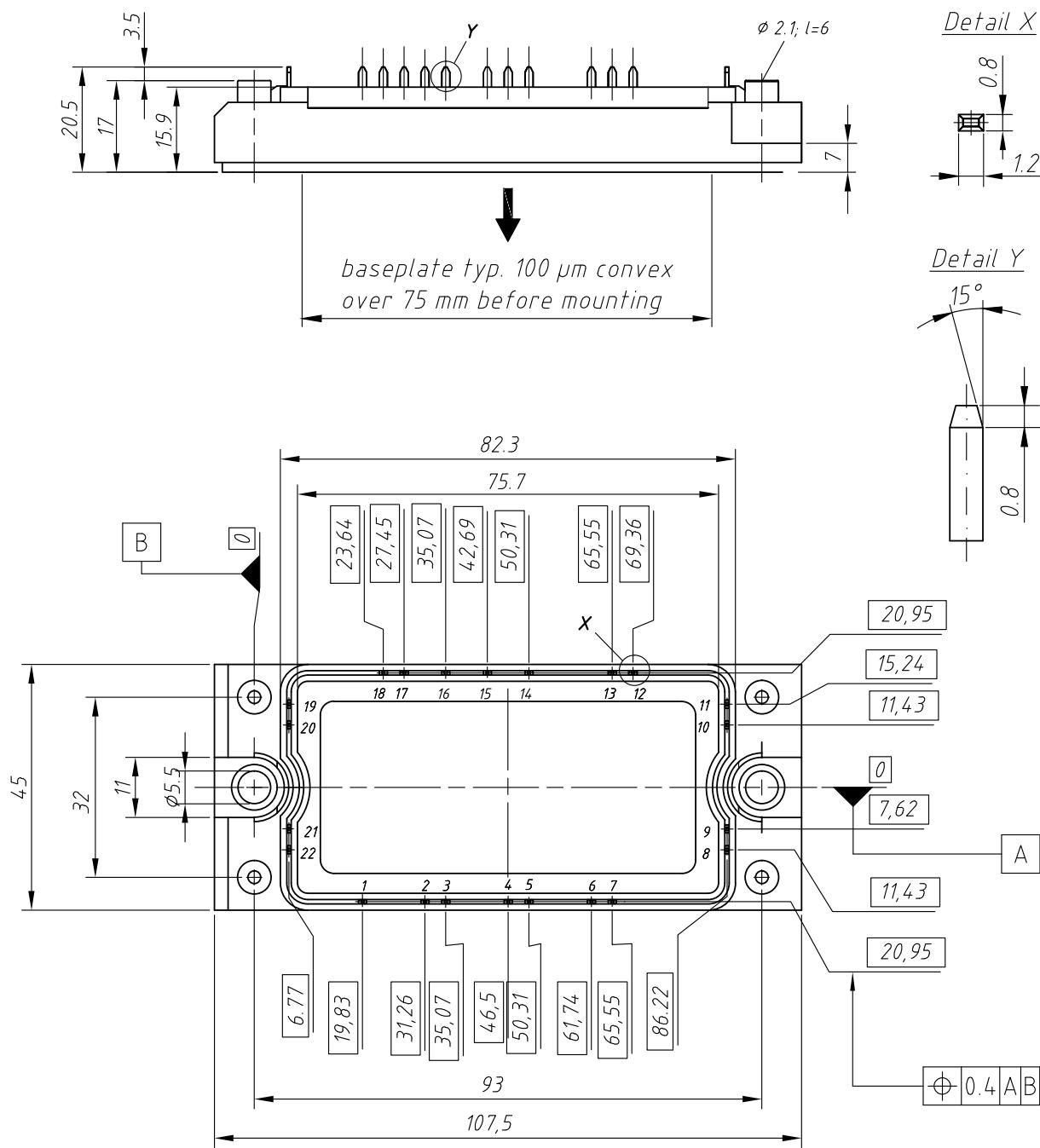
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Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	VVZB 170-16IOXT	VVZB170-16IOXT	Box	6	510482

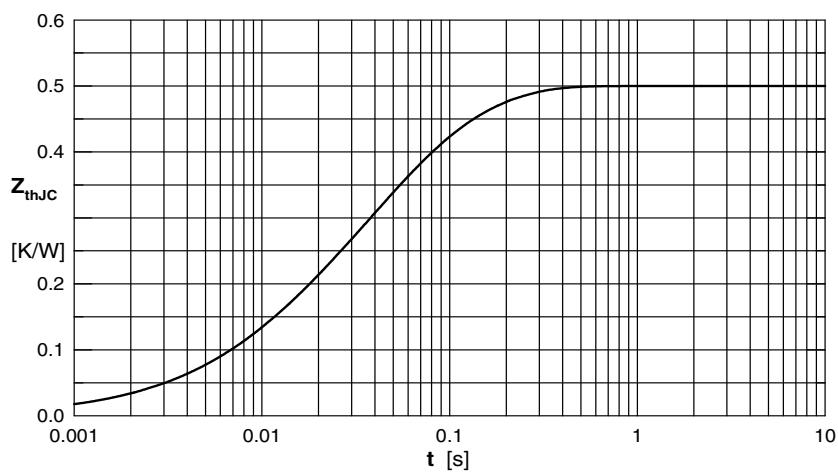
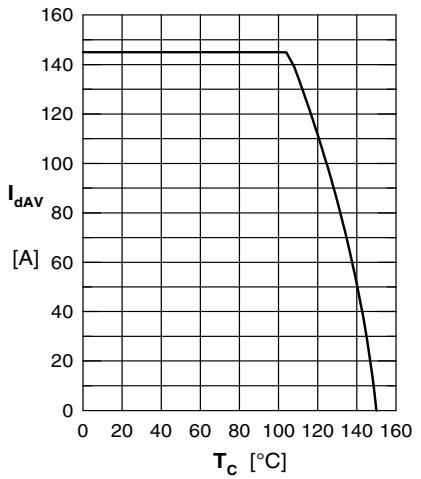
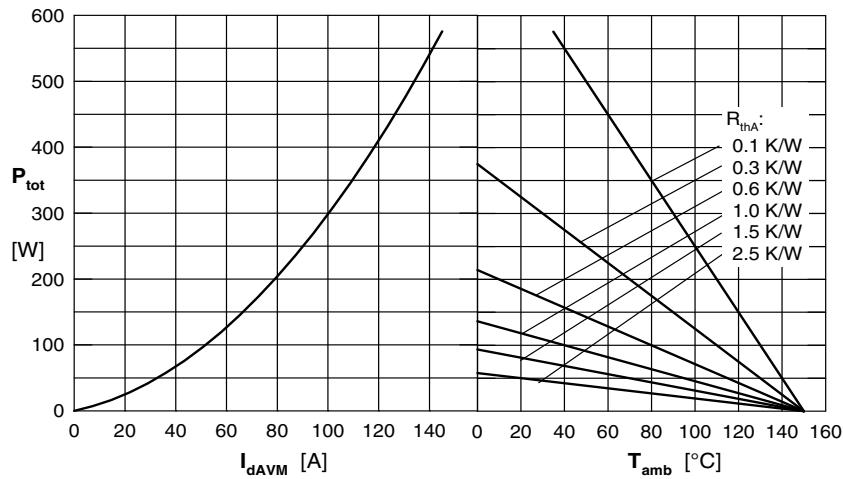
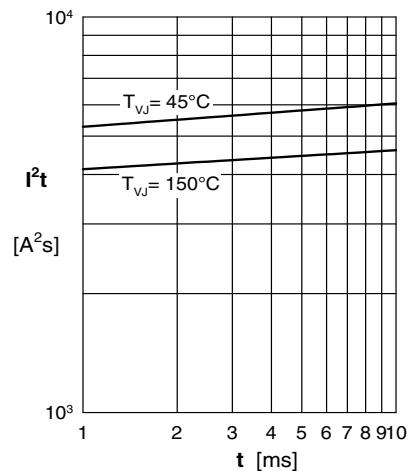
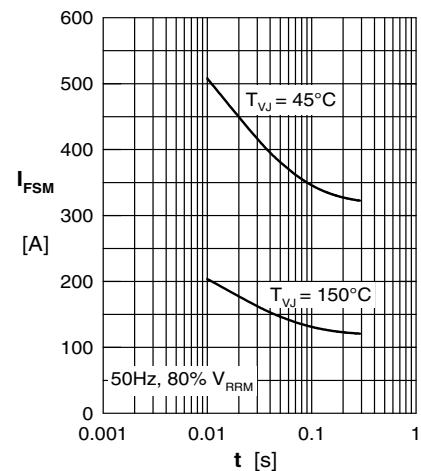
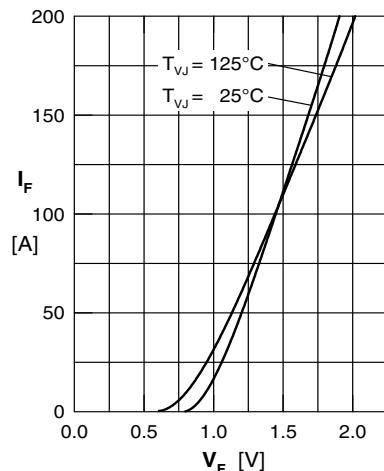
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Rectifier Bridge

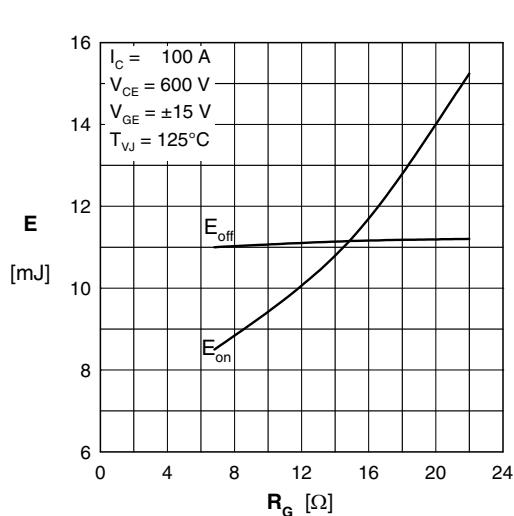
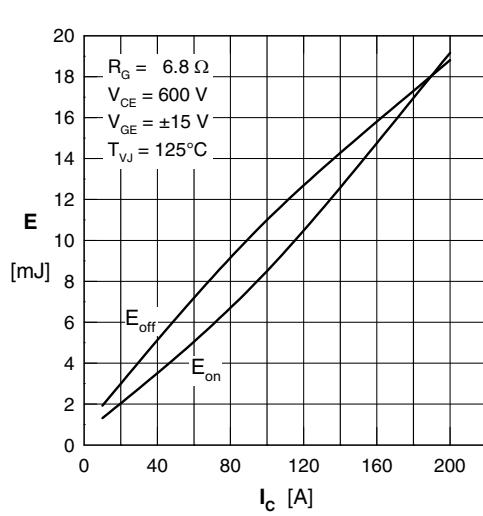
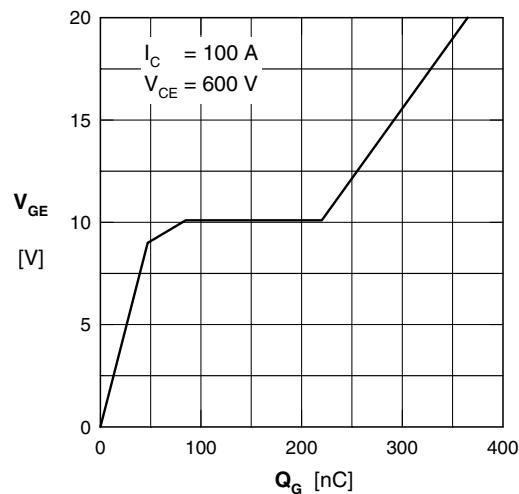
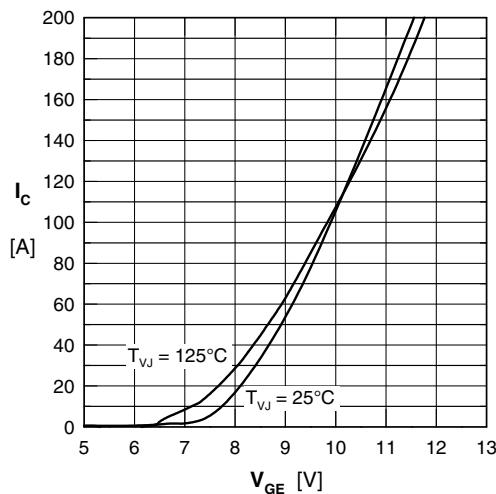
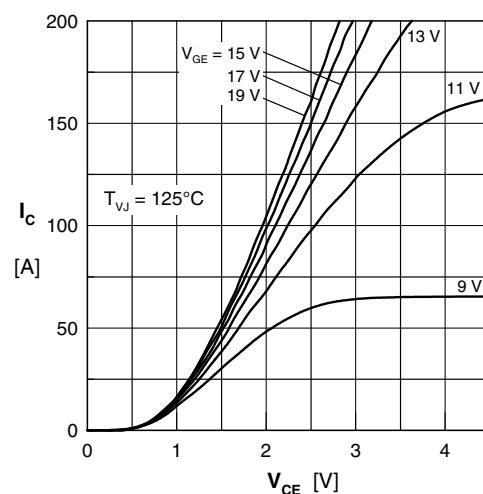
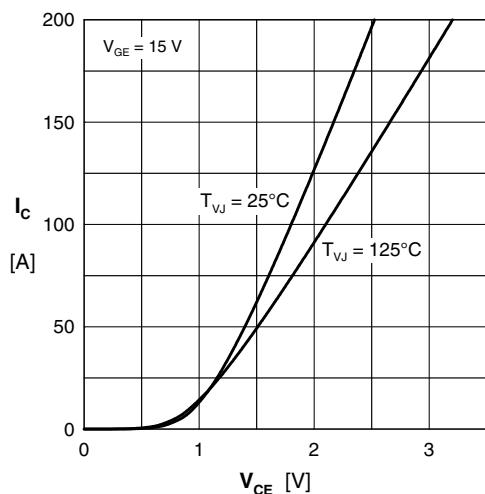


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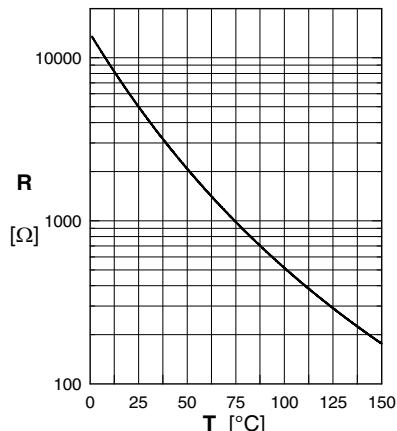
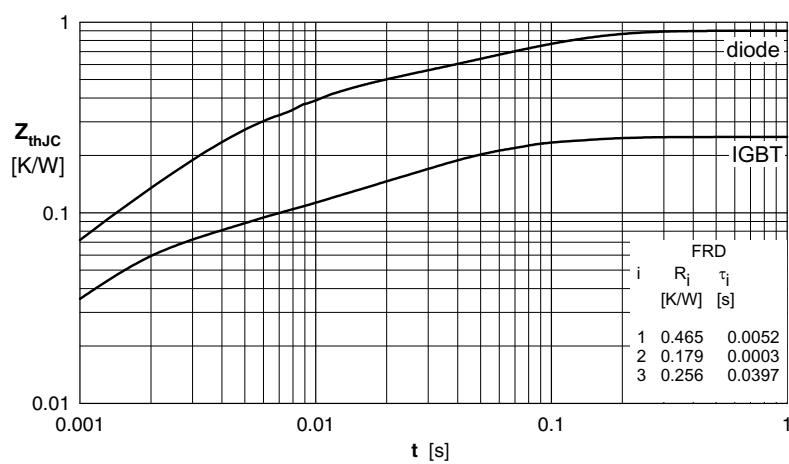
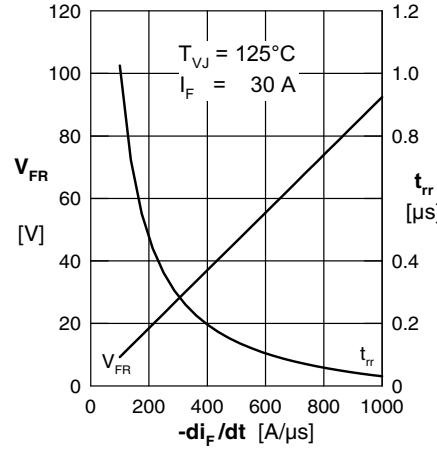
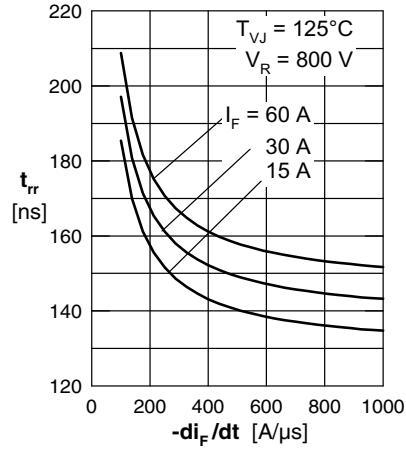
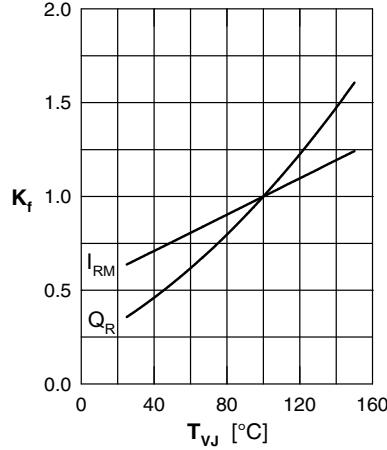
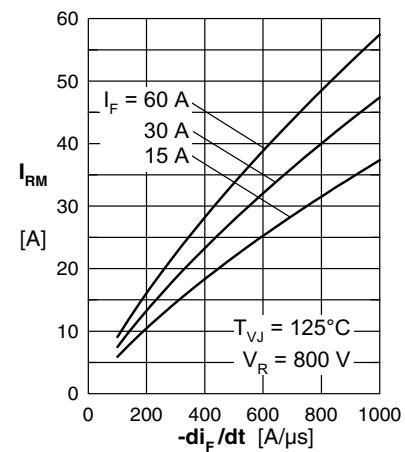
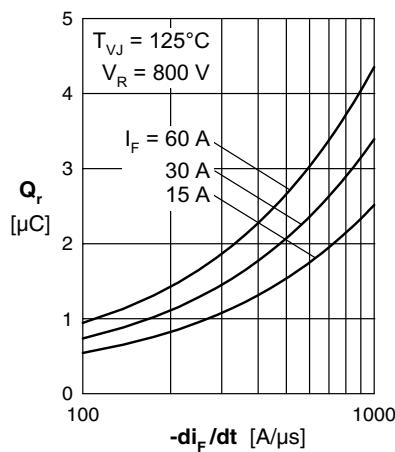
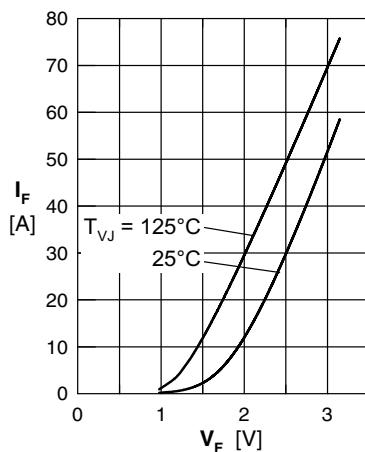
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Fast Recovery Diode

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